





	ASME Y14.5M CONNECTOR NOTES (2.) HOUSING MA POWER CONTA SIGNAL PIN 3. SEE ITEM 7 (4.) MANUFACTUR THIS SURFAC ON THIS SUF 5. PRODUCT SPE APPLICATION 6. PACKAGED IM PCB NOTES:	TERIAL: UL 94 V-0 GLA CT MATERIAL: COPPER ALL MATERIAL: COPPER ALL & 8 IN PRINT 1006418 ER'S NAME, DATE CODE E. THE P/N CAN BE OM FACE. CIFICATION GS-12-149 I SPECIFICATION BUS-2	ISE SPECIFIED. SS FILLED HIGH- ALLOY JY 3 FOR PLATING SF AND OPTIONAL P/ ITTED IF THERE I	TEMP THERMOPLASTIC PEC OF 51866-051 AT N TO APPEAR ON	ND 51866-051LF	F RESPECTIVELY.				
A	NOTE 3 NOTES: I. DIMENSIONS ASME YI4.5N CONNECTOR NOTES (2.) HOUSING MA POWER CONTA SIGNAL PIN 3. SEE ITEM 7 (4.) MANUFACTUR THIS SURFAC ON THIS SUF 5. PRODUCT SPE APPLICATION 6. PACKAGED IN PCB NOTES:	I, 1994 UNLESS OTHERW TERIAL: UL 94 V-0 GLA CT MATERIAL: COPPER ALL MATERIAL: COPPER ALL & 8 IN PRINT 1006418 ER'S NAME, DATE CODE E. THE P/N CAN BE OM FACE. CIFICATION GS-12-149 I SPECIFICATION BUS-2	ISE SPECIFIED. SS FILLED HIGH- ALLOY JY 3 FOR PLATING SF AND OPTIONAL P/ ITTED IF THERE I	TEMP THERMOPLASTIC PEC OF 51866-051 AT N TO APPEAR ON	ND 51866-051LF	F RESPECTIVELY.				
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3	CONNECTOR NOTES 2. HOUSING MA POWER CONTA SIGNAL PIN 3. SEE ITEM 7 4. MANUFACTUR THIS SURFAC ON THIS SUF 5. PRODUCT SPE APPLICATION 6. PACKAGED IN PCB NOTES:	TERIAL: UL 94 V-0 GLA CT MATERIAL: COPPER MATERIAL: COPPER ALL & 8 IN PRINT 1006418 ER'S NAME, DATE CODE E. THE P/N CAN BE OM FACE. CIFICATION GS-12-149 I SPECIFICATION BUS-2	.SS FILLED HIGH- ALLOY DY 3 FOR PLATING SF AND OPTIONAL P/ ITTED IF THERE I	PEC OF 51866-051 AN N TO APPEAR ON	ND 51866-051LF	F RESPECTIVELY.				
3	POWER CONTA SIGNAL PIN 3. SEE ITEM 7 4. MANUFACTUR THIS SURFAC ON THIS SUF 5. PRODUCT SPE APPLICATION 6. PACKAGED IN PCB NOTES:	CT MATERIAL: COPPER ALL MATERIAL: COPPER ALL & 8 IN PRINT 1006418 ER'S NAME, DATE CODE E. THE P/N CAN BE OM FACE. CIFICATION GS-12-149 I SPECIFICATION BUS-20	ALLOY DY 3 FOR PLATING SF AND OPTIONAL P/ ITTED IF THERE I	PEC OF 51866-051 AN N TO APPEAR ON	ND 51866-051LF	F RESPECTIVELY.				
3	 MANUFACTUR THIS SURFAC ON THIS SUF PRODUCT SPE APPLICATION PACKAGED IN PCB NOTES: 	ER'S NAME, DATE CODE E. THE P/N CAN BE OM FACE. CIFICATION GS-12-149 I SPECIFICATION BUS-2	AND OPTIONAL P/ ITTED IF THERE I	N TO APPEAR ON		F RESPECTIVELY.				
В	THIS SURFAC ON THIS SUF 5. PRODUCT SPE APPLICATION 6. PACKAGED IN PCB NOTES:	E. THE P/N CAN BE OM FACE. CIFICATION GS-12-149 SPECIFICATION BUS-2	ITTED IF THERE I		<u>-</u>					
В	APPLICATION 6. PACKAGED IN PCB NOTES:	SPECIFICATION BUS-2								
	PCB NOTES:	TRAYS.								
	7. ALL HULE L	IAMETERS ARE FINISHE	D HOLE SIZE.							
	8. MOUNTING H	DLES, WHERE APPLICABL	E, ARE UNPLATED							
3	0.008 MIN S	025 DRILLED HOLES PLA nPb OR Sn OVER 0.03 PLATING TO ACHIEVE HOLE.	TED WITH							
	(10.) "DIM XXX"	TO BE DETERMINED BY T	HE CUSTOMER.							
	(I.) CONNECTOR	KEEP-OUT ZONE.								
	MODULES AND MAY BE DIFF	RING IN BETWEEN POWE END MODULES ARE OPT ERENT FOR OPTIMIZE T WILL NOT EFFECT TO	IONAL AND THE SH HE MOLDING PROCE	HAPE ISS. THE						
	I3. USE FCI C	AM TOOL 430140-XXX CONNECTOR TO PCB.		dr XQ Wang	2012	/02/22	projection		size	scale
	IO AFFLI	CONNECTOR TO FCD.		eng XQ Wang		/02/27		MM	A 4	1:1
				chr -	-				ecn no	-
				appr Pei-Ming Zheng	g 2012	/02/27	product family	PwrBlac	de rel level	Released
				FCi	<u></u> 6P +	+ 24S		0 C		rev
					·=	OLDER RECE	F P T A C L F	d × b	51866-05	A
				www.fci.com	11777 0		I		mer Drw st	heet 4 of 4